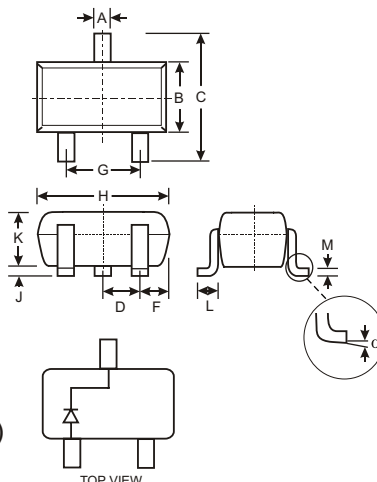


Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance

Mechanical Data

- Case: SOT-323, Molded Plastic
- Case Material - UL Flammability Rating Classification 94V-0
- Moisture sensitivity: Level 1 per J-STD-020A
- Terminals: Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- BAS19W Marking: KA8 or KT2 or KT3 (See Page 3)
- BAS20W Marking: KT2 or KT3 (See Page 3)
- BAS21W Marking: KT3 (See Page 3)
- Weight: 0.006 grams (approx.)



SOT-323		
Dim	Min	Max
A	0.25	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.18
α	0°	8°
All Dimensions in mm		

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	BAS19W	BAS20W	BAS21W	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage	V_{RWM} V_R	100	150	200	V
RMS Reverse Voltage	$V_{R(RMS)}$	71	106	141	V
Forward Continuous Current (Note 1)	I_{FM}		400		mA
Average Rectified Output Current (Note 1)	I_O		200		mA
Non-Repetitive Peak Forward Surge Current @ $t = 1.0\mu\text{s}$ @ $t = 1.0\text{s}$	I_{FSM}		2.5 0.5		A
Repetitive Peak Forward Surge Current	I_{FRM}		625		mA
Power Dissipation	P_d		200		mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{\theta JA}$		625		$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}		-65 to +150		$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	120 200 250	— — —	V	$I_R = 100\mu\text{A}$
Forward Voltage (Note 2)	V_F	—	1.0 1.25	V	$I_F = 100\text{mA}$ $I_F = 200\text{mA}$
Reverse Current @ Rated DC Blocking Voltage (Note 2)	I_R	—	100 15	nA μA	$T_J = 25^\circ\text{C}$ $T_J = 100^\circ\text{C}$
Total Capacitance	C_T	—	5.0	pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}	—	50	ns	$I_F = I_R = 30\text{mA}$, $t_{rr} = 0.1 \times I_R, R_L = 100\Omega$

Notes: 1. Part mounted on FR-4 PC board with minimum recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
2. Short duration test pulse used to minimize self-heating effect.

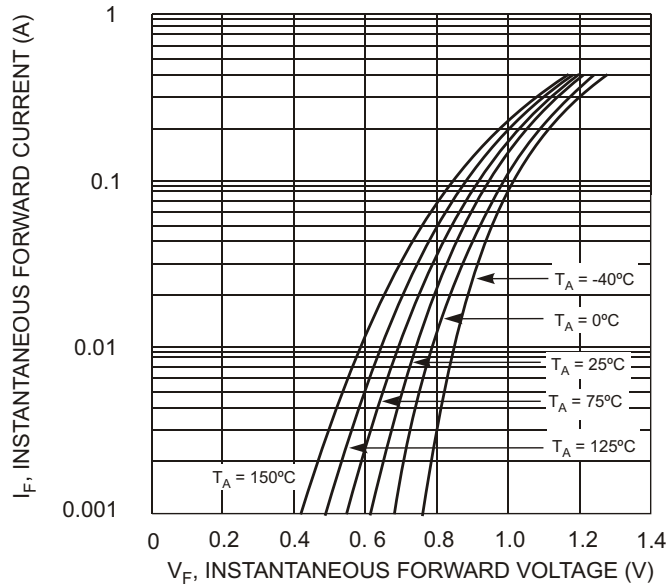


Fig. 1 Typical Forward Characteristics

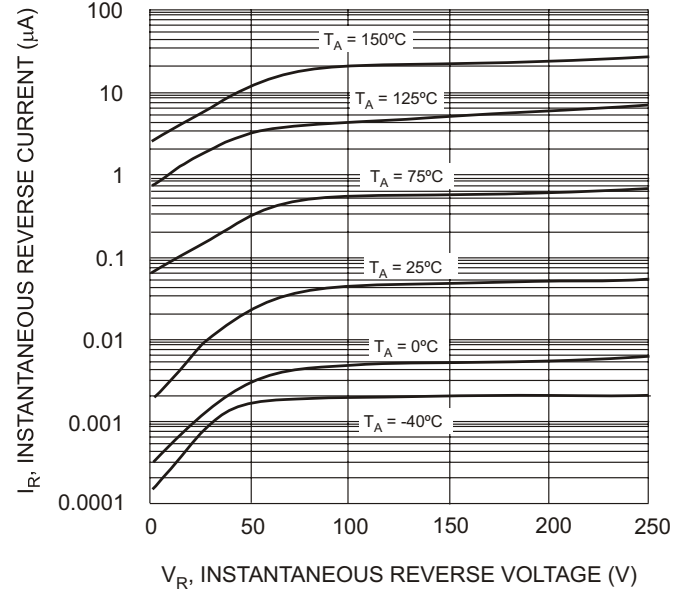


Fig. 2 Typical Reverse Characteristics

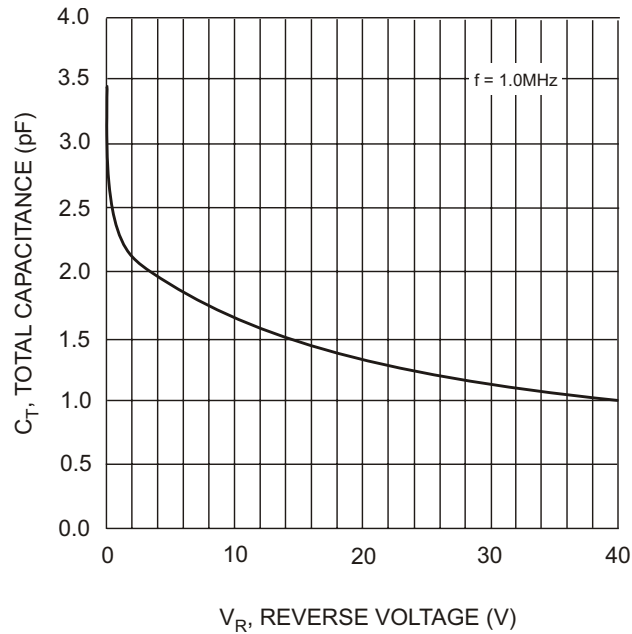


Fig. 3 Typical Capacitance vs. Reverse Voltage

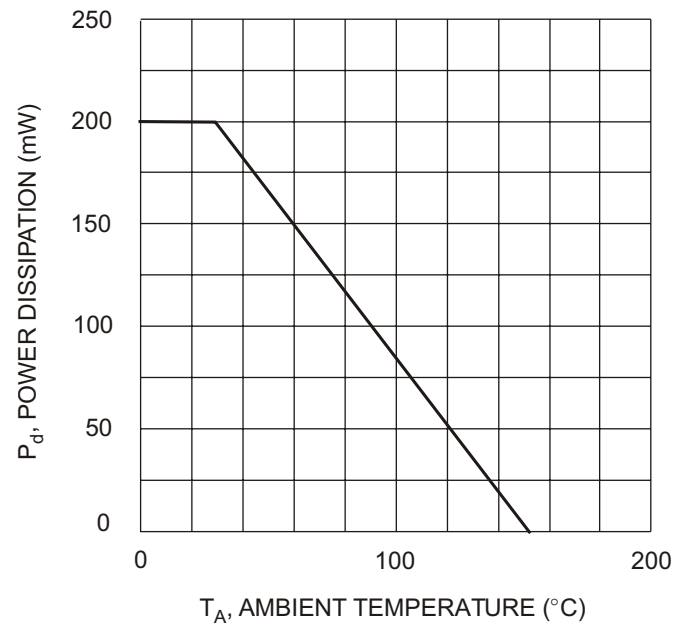
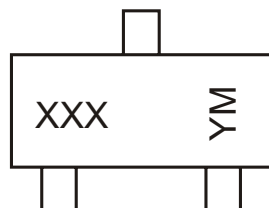


Fig. 4 Power Derating Curve, Total Package

Ordering Information (Note 3)

Device	Packaging	Shipping
BAS19W-7	SOT-323	3000/Tape & Reel
BAS20W-7	SOT-323	3000/Tape & Reel
BAS21W-7	SOT-323	3000/Tape & Reel

Notes: 3. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information

XXX = Product Type Marking Code (See Page 1 Diagrams)

YM = Date Code Marking

Y = Year ex: N = 2002

M = Month ex: 9 = September

Date Code Key

Year	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009
Code	L	M	N	P	R	S	T	U	V	W

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D